

RoHS

COMPLIANT HALOGEN

Available

Vishay Siliconix

P-Channel 20-V (D-S) MOSFET

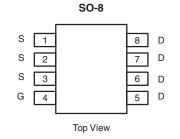
| PRODUCT SUMMARY | | | | |
|---------------------|--|--------------------|-----------------------|--|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) | Q _g (Typ.) | |
| - 20 | 0.065 at V _{GS} = - 4.5 V | - 5 | 4.5 nC | |
| | 0.105 at V _{GS} = - 2.5 V | - 4.1 | 4.5 110 | |

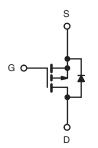
FEATURES

- Halogen-free According to IEC 61249-2-21
 Available
- TrenchFET[®] Power MOSFET
- PWM Optimized, Low Q_{qd}/Q_{qs} Ratio

APPLICATIONS

- Step-Down Converter for HDD Applications
- Portable Asynchronous DC-DC





P-Channel MOSFET

Ordering Information: Si4803DY-T1-E3 (Lead (Pb)-free) Si4803DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

| Parameter | Symbol | Limit | Unit | |
|--|------------------------|-----------------------------------|-----------------------|-----|
| Drain-Source Voltage | V _{DS} | - 20 | V | |
| Gate-Source Voltage | | V _{GS} | ± 12 | |
| | T _C = 25 °C | | - 5 | |
| Continuous Drain Current (T 150 °C) | T _C = 70 °C | | - 4 | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | I _D | - 4 ^{a, b} | |
| | T _A = 70 °C | | - 3.1 ^{a, b} | • |
| Pulsed Drain Current | | I _{DM} | - 20 | — A |
| Continuous Source-Drain Diode Current | T _C = 25 °C | | - 2.6 | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 1.6 ^{a, b} | |
| Avalanche Current | L = 0.1 mH | I _{AS} | 5 | |
| Single-Pulse Avalanche Energy L = 0. | | E _{AS} | 1.25 | mJ |
| | T _C = 25 °C | | 3.0 | |
| Maximum Power Dissipation | T _C = 70 °C | Б | 1.9 | |
| | T _A = 25 °C | P _D | 2 ^{a, b} | |
| | T _A = 70 °C | 1 - | 1.2 ^{a, b} | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stq} | - 55 to 150 | °C |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 52 | 62.5 | °C/W | |
| Maximum Junction-to-Foot | Steady State | R _{thJF} | 35 | 42 | | |

Notes:

c. Maximum under Steady State conditions is 110 °C/W.

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

Si4803DY

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|--|--|-------|--------|-------|-------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = - 250 μA | - 20 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | 1 050 4 | | - 20 | | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | ID = - 250 IIA | | 3 | | mV/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 0.6 | | - 1.5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 12 V$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -20 V, V_{GS} = 0 V$ | -1 | | | | |
| | | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$ | | | - 10 | μΑ | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge$ - 10 V, V_{GS} = - 4.5 V | - 10 | | | Α | |
| Drain-Source On-State Resistance ^a | | $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.5 \text{ A}$ | | 0.052 | 0.065 | Ω | |
| | R _{DS(on)} | V _{GS} = - 2.5 V, I _D = - 3 A | | 0.085 | 0.105 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 3.5 A | | 10 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 480 | | | |
| Output Capacitance | C _{oss} | V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz | | 132 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 55 | | | |
| Takal Oaka Okanaa | $Q_{g} = \frac{V_{DS} = -10 \text{ V}, \text{ V}_{C}}{-10 \text{ V}, \text{ V}_{C}}$ | V _{DS} = - 10 V, V _{GS} = - 10 V, I _D = - 5 A | | 9.7 | 14.5 | nC | |
| Total Gate Charge | | | | 4.5 | 7 | | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_{D} = - 5 A | | 1 | | | |
| Gate-Drain Charge | Q _{gd} | | | 1 | | | |
| Gate Resistance | R _g | f = 1 MHz | | 7.5 | 15 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 4 | 8 | - ns | |
| Rise Time | t _r | V_{DD} = - 10 V, R_L = 2 Ω | | 10 | 20 | | |
| Turn-Off DelayTime | t _{d(off)} | ${ m I}_{ m D}\cong$ - 5 A, ${ m V}_{ m GEN}$ = - 10 V, ${ m R}_{ m g}$ = 1 Ω | | 16 | 30 | | |
| Fall Time | t _f | | | 8 | 16 | | |
| Turn-On Delay Time | t _{d(on)} | | | 20 | 35 | | |
| Rise Time | t _r | V_{DD} = - 10 V, R_L = 2 Ω | | 50 | 90 | | |
| Turn-Off DelayTime | t _{d(off)} | ${ m I}_{ m D}\cong$ - 5 A, ${ m V}_{ m GEN}$ = - 4.5 V, ${ m R}_{ m g}$ = 1 Ω | | 16 | 30 | | |
| Fall Time | t _f | | | 10 | 20 | | |
| Drain-Source Body Diode Characterist | ics | | • | • | • | | |
| Continous Source-Drain Diode Current | ۱ _s | T _C = 25 °C | | | - 2.6 | Δ | |
| Pulse Diode Forward Current | I _{SM} | | | | - 20 | A | |
| Body Diode Voltage | V _{SD} | I _S = - 1 A, V _{GS} = 0 V | | - 0.75 | - 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 25 | 38 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 11.25 | 17 | nC | |
| Reverse Recovery Fall Time | t _a | $I_F = -3.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$ | | 9 | | ns | |
| Reverse Recovery Rise Time | t _b | | | 16 | | | |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

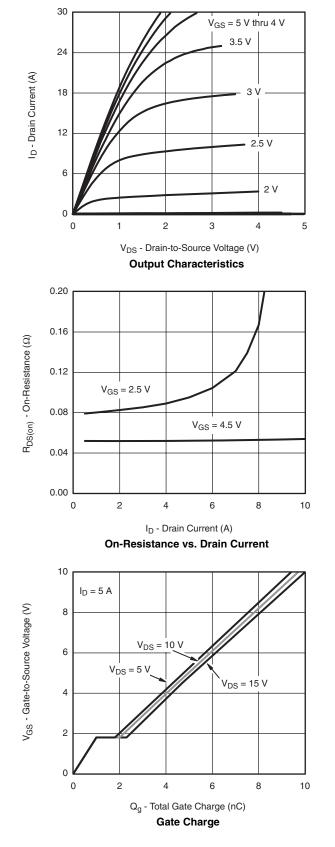
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

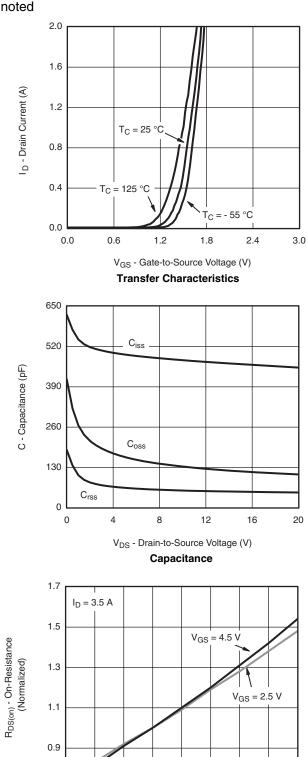
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





50 T_J - Junction Temperature (°C) **On-Resistance vs. Junction Temperature**

75

100

0.7

- 50

- 25

0

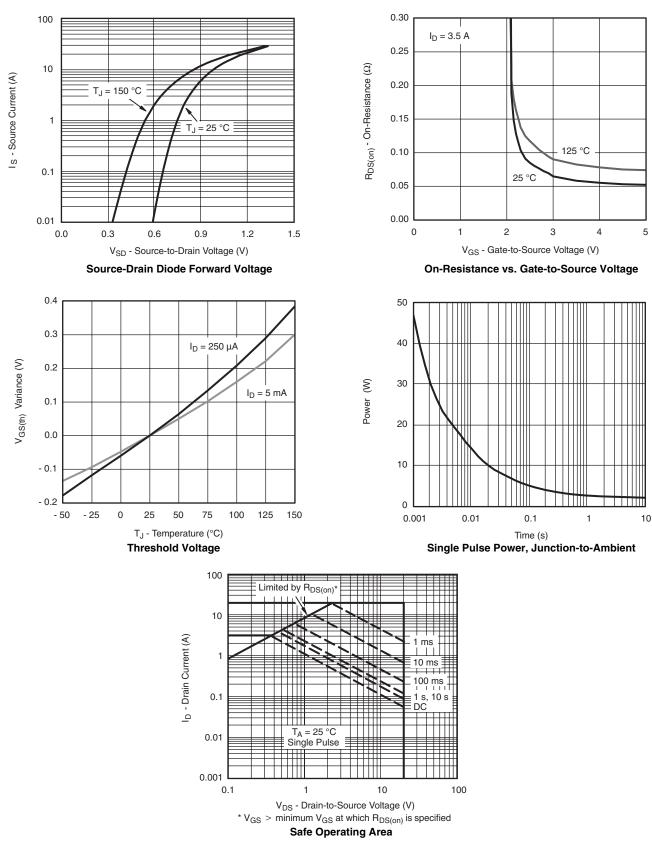
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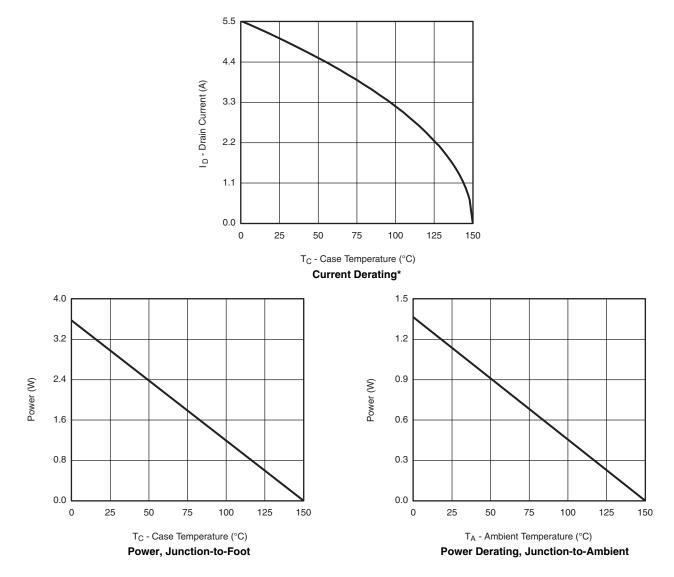
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Si4803DY Vishay Siliconix

MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

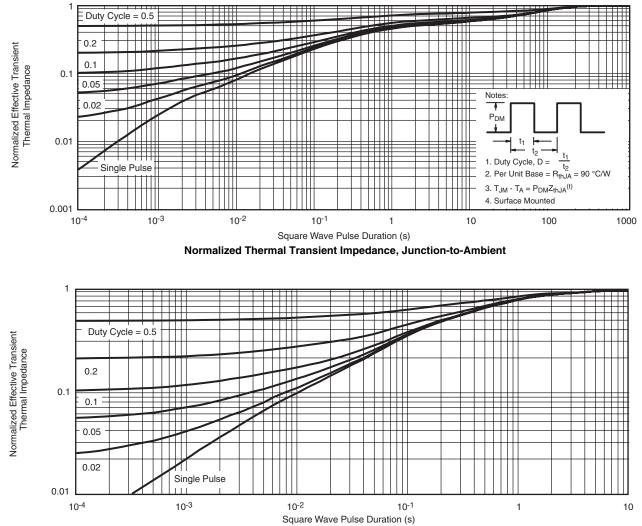


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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